Quad 2-Input NAND Gate

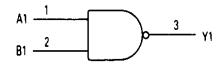
High-Performance Silicon-Gate CMOS

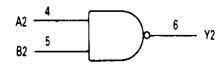
The SL74HC00 is identical in pinout to the LS/ALS00. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LS/ALSTTL outputs.

- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0 µA
- High Noise Immunity Characteristic of CMOS Devices

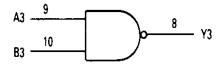


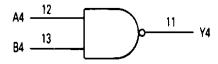
LOGIC DIAGRAM





 $Y = \overline{AB}$





PIN $14 = V_{CC}$ PIN 7 = GND

PIN ASSIGNMENT

AI [1.	14	v_{cc}
BI [2	13	B4
Yı 🛚	3	12	Λ4
A2 [4	II .	¥4
R2 [Ki.	Bà
¥2 [6	9	43
CND [7	δ	¥3

FUNCTION TABLE

Inputs		Output
A	В	Y
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
$V_{\rm IN}$	DC Input Voltage (Referenced to GND)	-1.5 to V_{CC} +1.5	V
V_{OUT}	DC Output Voltage (Referenced to GND)	-0.5 to V_{CC} +0.5	V
I_{IN}	DC Input Current, per Pin	±20	mA
I_{OUT}	DC Output Current, per Pin	±25	mA
I_{CC}	DC Supply Current, V _{CC} and GND Pins	±50	mA
P_{D}	Power Dissipation in Still Air, Plastic DIP+ SOIC Package+	750 500	mW
Tstg	Storage Temperature	-65 to +150	°C
$T_{\rm L}$	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package)	260	°C

^{*}Maximum Ratings are those values beyond which damage to the device may occur.

Functional operation should be restricted to the Recommended Operating Conditions.

SOIC Package: : - 7 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Max	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)		6.0	V
$V_{\rm IN}, V_{\rm OUT}$	DC Input Voltage, Output Voltage (Referenced to GND)		V_{CC}	V
T_{A}	Operating Temperature, All Package Types		+125	°C
t _r , t _f	Input Rise and Fall Time (Figure 1) $V_{CC} = 2.0 \text{ V}$ $V_{CC} = 4.5 \text{ V}$ $V_{CC} = 6.0 \text{ V}$	0 0 0	1000 500 400	ns

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range $GND \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

⁺Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

			V_{CC}	Guaranteed Limit			
Symbol	Parameter	Test Conditions	V	25 °C to -55°C	≤85 °C	≤125 °C	Unit
V _{IH}	Minimum High-Level Input Voltage	V_{OUT} =0.1 V or V_{CC} -0.1 V $ I_{OUT} \le 20 \mu\text{A}$	2.0 4.5 6.0	1.5 3.15 4.2	1.5 3.15 4.2	1.5 3.15 4.2	V
$V_{\rm IL}$	Maximum Low -Level Input Voltage	$\begin{aligned} V_{\text{OUT}} &= V_{\text{CC}} - 0.1 \text{ V} \\ \mid I_{\text{OUT}} \mid &\leq 20 \mu\text{A} \end{aligned}$	2.0 4.5 6.0	0.5 1.35 1.8	0.5 1.35 1.8	0.5 1.35 1.8	V
V_{OH}	Minimum High-Level Output Voltage	$\begin{aligned} &V_{\rm IN} {=} V_{\rm IH} \text{ or } V_{\rm IL} \\ &\mid I_{\rm OUT} \mid \leq 20 \ \mu A \end{aligned}$	2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V
		$V_{\rm IN} = V_{\rm IH}$ or $V_{\rm IL}$ $\mid I_{\rm OUT} \mid \le 4.0 \text{ mA}$ $\mid I_{\rm OUT} \mid \le 5.2 \text{ mA}$	4.5 6.0	3.98 5.48	3.84 5.34	3.7 5.2	
V _{OL}	Maximum Low-Level Output Voltage	$\begin{vmatrix} V_{\rm IN} = V_{\rm IH} \\ I_{\rm OUT} \end{vmatrix} \le 20 \mu\text{A}$	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V
		$\begin{split} & V_{\rm IN} {=} V_{\rm IH} \\ & \mid I_{\rm OUT} \mid \leq 4.0 \ \rm mA \\ & \mid I_{\rm OUT} \mid \leq 5.2 \ \rm mA \end{split}$	4.5 6.0	0.26 0.26	0.33 0.33	0.4 0.4	
$I_{\rm IN}$	Maximum Input Leakage Current	V _{IN} =V _{CC} or GND	6.0	±0.1	±1.0	±1.0	μΑ
I_{CC}	Maximum Quiescent Supply Current (per Package)	$V_{\rm IN} = V_{\rm CC}$ or GND $I_{\rm OUT} = 0 \mu A$	6.0	1.0	10	40	μА

$\textbf{AC ELECTRICAL CHARACTERISTICS}(C_L = 50 \text{pF}, Input \ t_r = t_f = 6.0 \ \text{ns})$

			V _{CC} Guaranteed Limit			
Symbol	Parameter	V	25 °C to -55°C	≤85°C	≤125°C	Unit
$t_{\rm PLH}, t_{\rm PHL}$	Maximum Propagation Delay, Input A or B to Output Y (Figures 1 and 2)	2.0 4.5 6.0	75 15 13	95 19 16	110 22 19	ns
t_{TLH}, t_{THL}	Maximum Output Transition Time, Any Output (Figures 1 and 2)	2.0 4.5 6.0	75 15 13	95 19 16	110 22 19	ns
C_{IN}	Maximum Input Capacitance	-	10	10	10	pF

Power Dissipation Capacitance (Per Gate)	Typical @25°C,V _{CC} =5.0 V	
Used to determine the no-load dynamic power consumption: $P_D=C_{PD}V_{CC}^2$ f+ $I_{CC}V_{CC}$	22	pF

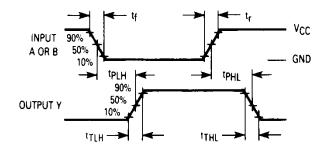
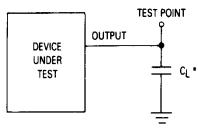


Figure 1. Switching Waveforms



*Includes all probe and jig capacitance.

Figure 2. Test Circuit

EXPANDED LOGIC DIAGRAM (1/4 of the Device)

